

ハーフメタルのスピントロニクスデバイス応用と 軟X線MCD解析

*- Applications of half-metals to spintronics devices and
utilizations of soft X-ray magnetic circular dichroism -*

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JASRI/Spring-8

Outline

- **Introduction** : Half-metallic materials
Half-metallic Heusler alloys

- **Experiments**

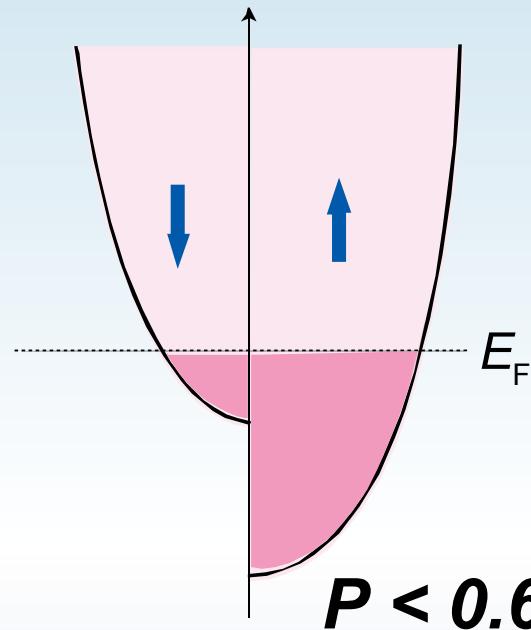
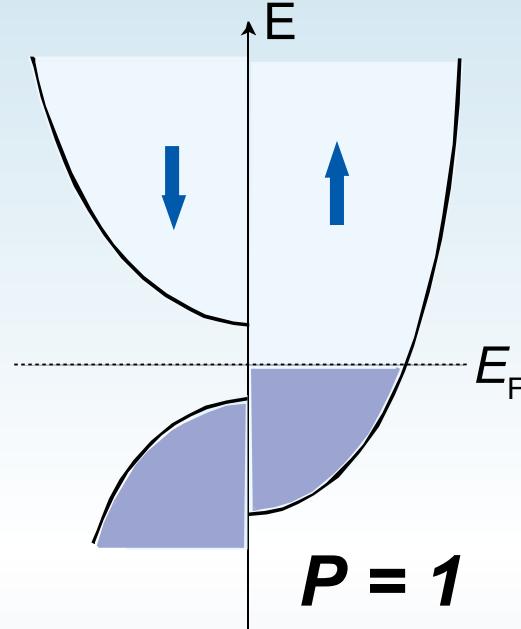
Experiment 1 Co₂MnSi-based magnetic tunnel junctions

Experiment 2 MTJs with L1₀/L2₁-ordered alloy hybrid electrodes

Experiment 3 Half-metallic Ferri-magnets : Mn₂VAI

Experiment 4 Co₂MnSi-based CPP-GMR devices

- **Summary**

3d Ferromagnet**Half-metal**

Spin-polarization

$$P = \frac{D_{\uparrow}(E_F) - D_{\downarrow}(E_F)}{D_{\uparrow}(E_F) + D_{\downarrow}(E_F)}$$

Candidates of half-metallic materials

Oxides : CrO₂, Fe₃O₄, La_{2/3}Sr_{1/3}MnO₃ etc.

Zinc-blend type compounds: CrAs, MnAs etc.

Half-Heusler alloys: NiMnSn, PtMnSb etc.

Full-Heusler alloys : Co₂MnSi, Co₂MnGe, etc.

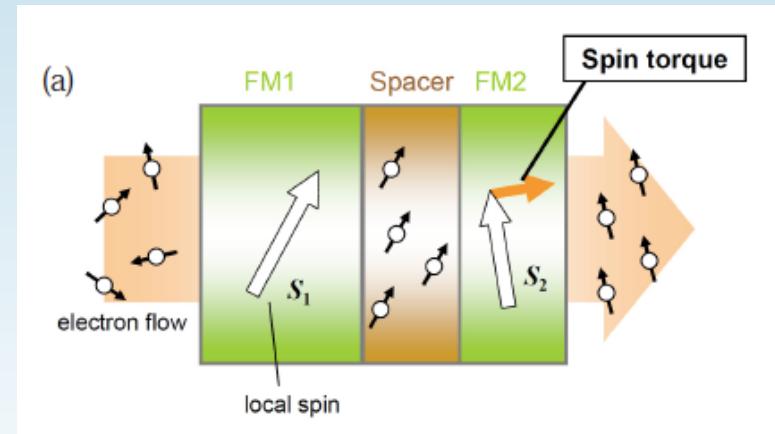
- MTJs & CPP-GMR devices

$$TMR \ ratio = \frac{2P_1P_2}{1-P_1P_2} \times 100 \ (%)$$

Spin-torque induced magnetization switching

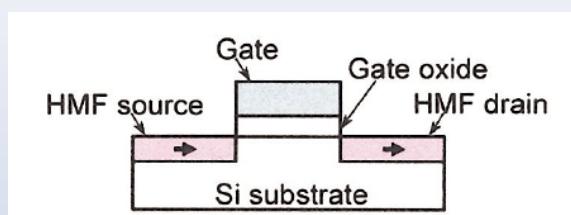
$$J_C \propto \frac{\alpha}{g(\theta)} M_s^2 t$$

Spin-injection efficiency : $g(\theta) = P_1 / (1 + P_1 P_2 \cos \theta)$

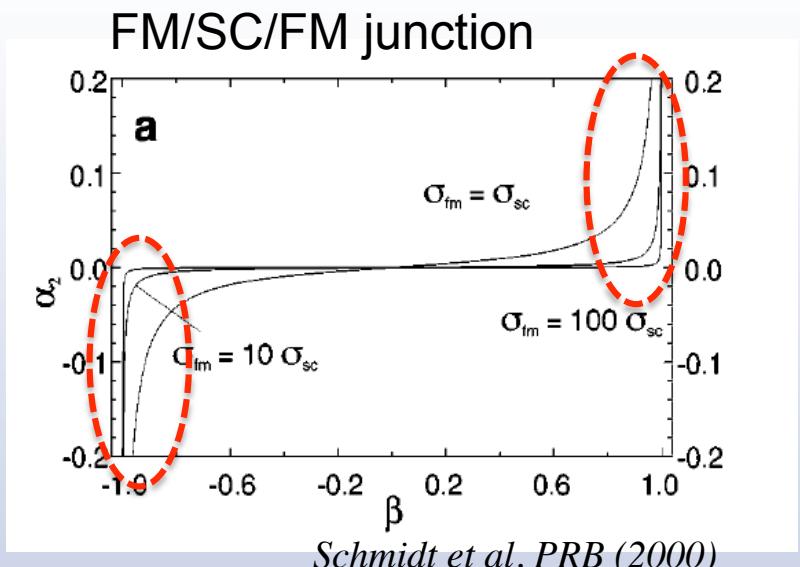
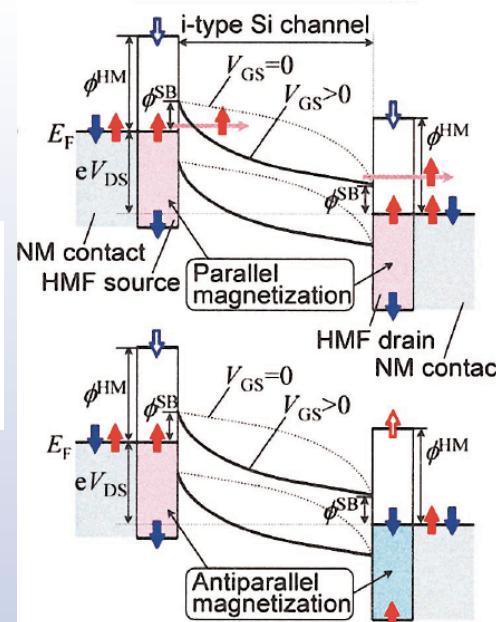


- Spin-Transistor

Spin-MOSFET based on Half-metallic source and drain



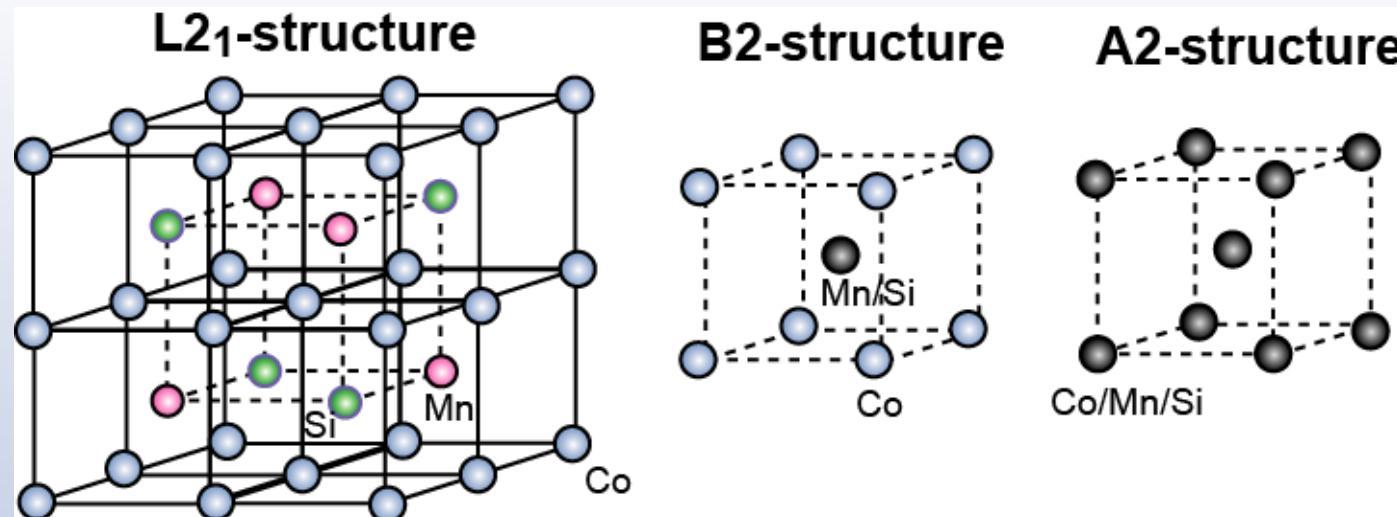
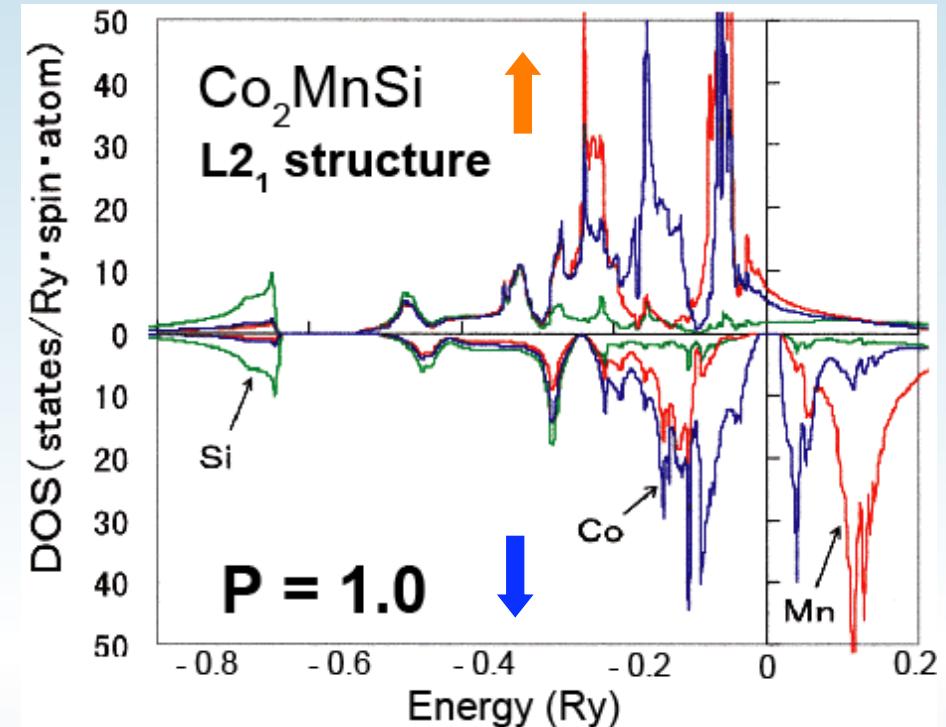
Sugahara et al. APL (2004)



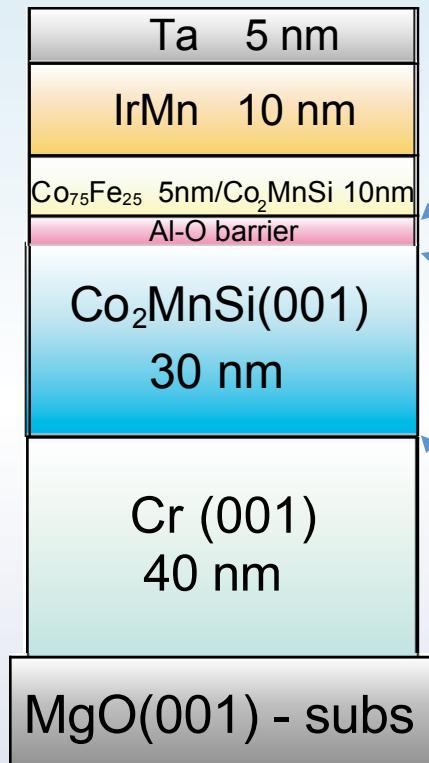
Co_2MnSi (CMS)

- High Curie temp.: $T_C \sim 985$ K
- Half-metallic energy gap E_G : $0.4 \sim 0.6$ eV
- High degree of $\text{L}2_1$ chemical ordering is easily obtained

CMS is a promising candidate in the half-metal candidates.



UHV magnetron sputtering system ($P < 1 \times 10^{-7}$ Pa)



MTJ

Al-O barrier : Plasma oxidation of Al layer
 Micro-fabrication : PL & Ar ion milling
 (element size : $5 \times 5 - 100 \times 100 \mu\text{m}^2$)
 Annealing : $200 - 500^\circ\text{C}$ with applying H
 MR, I-V curve : DC 4-probe method

Co₂MnSi bottom epitaxial electrode

Composition : Target $\text{Co}_{2.00}\text{Mn}_{1.28}\text{Si}_{1.30} \rightarrow$ Film : $\text{Co}_{2.00}\text{Mn}_{1.00}\text{Si}_{1.08}$
 Deposited@RT → Post-annealed@ $T_a = 250 - 650^\circ\text{C}$
 Crystal structure, the degree of ordering : XRD
 Magnetization : SQUID,VSM
 Surface image : AFM

Cr buffer layer

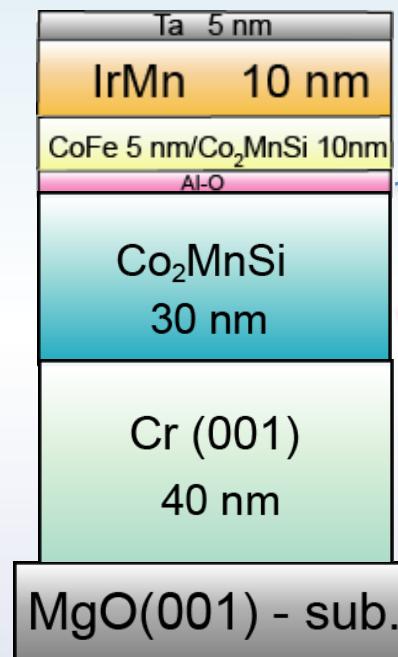
Deposited@RT → Post-annealed@ 700°C

Epitaxial relation :

$\text{MgO}(001)\langle 100 \rangle/\text{Cr}(001)\langle 110 \rangle/\text{CMS}(001)\langle 110 \rangle$

Lattice misfit < 5%

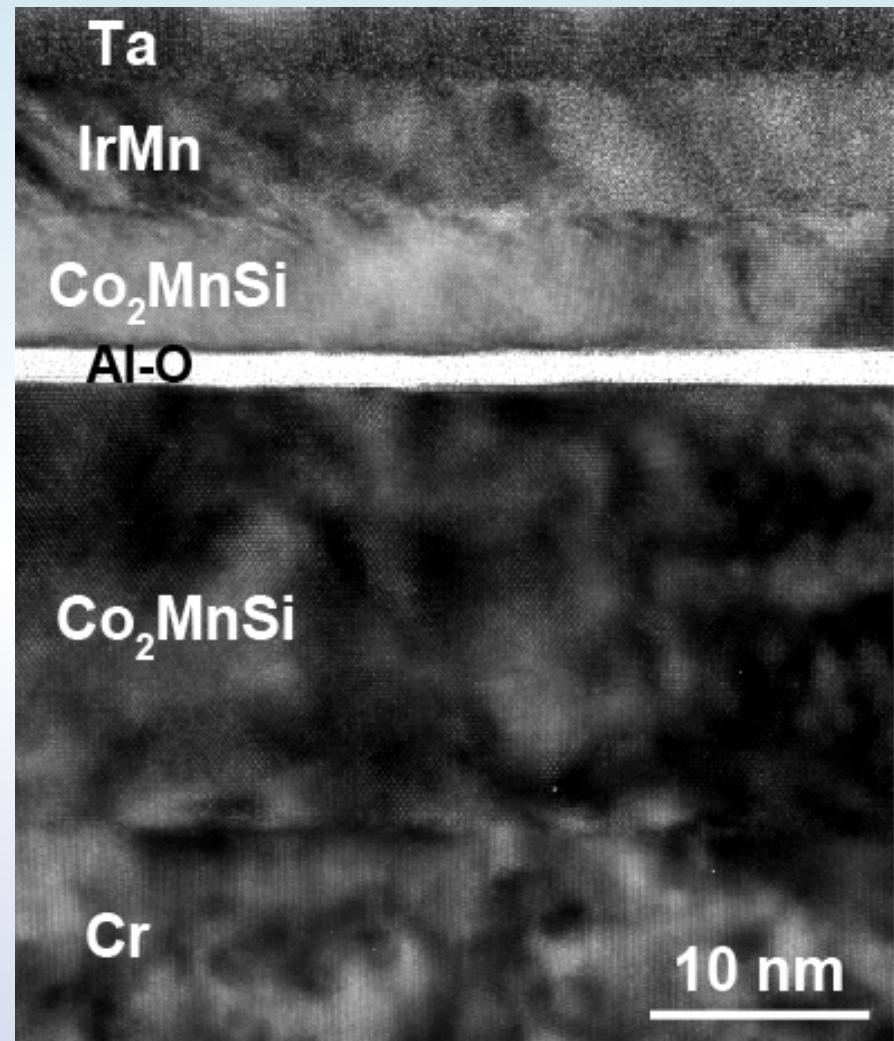
Magnetic tunnel junction (MTJs) with epitaxial CMS bottom electrode



Conventional Al-O amorphous barrier

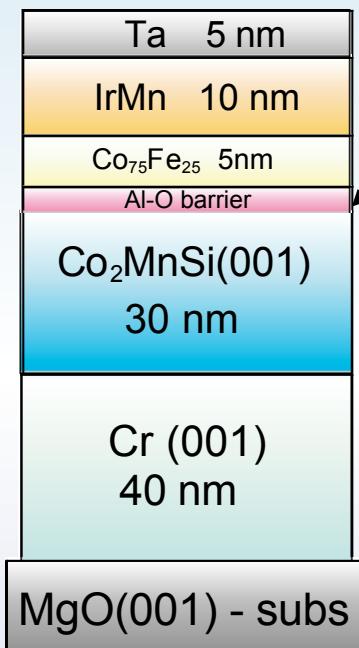
Flat surface
 $R_a < 0.2 \text{ nm}$
Stoichiometry
 $\text{Co}_{2.00}\text{Mn}_{1.00}\text{Si}_{1.08}$ (ICP)
Highly L₂1-ordering
 $S_{L21} > 0.8$ (XRD)

HR-TEM image



Extremely flat and sharp interfacial morphology

Co_2MnSi : Mn has large affinity to oxygen compared to conventional 3d FM.



Magnetic impurities easily create between CMS/Al-O interface.

Optimization of interfacial chemical conditions is necessary.

1. Plasma oxidation time for Al-O : $t_{\text{ox}} = 10 - 240 \text{ s}$

2. Insert thin Mg layer between CMS and Al-O.

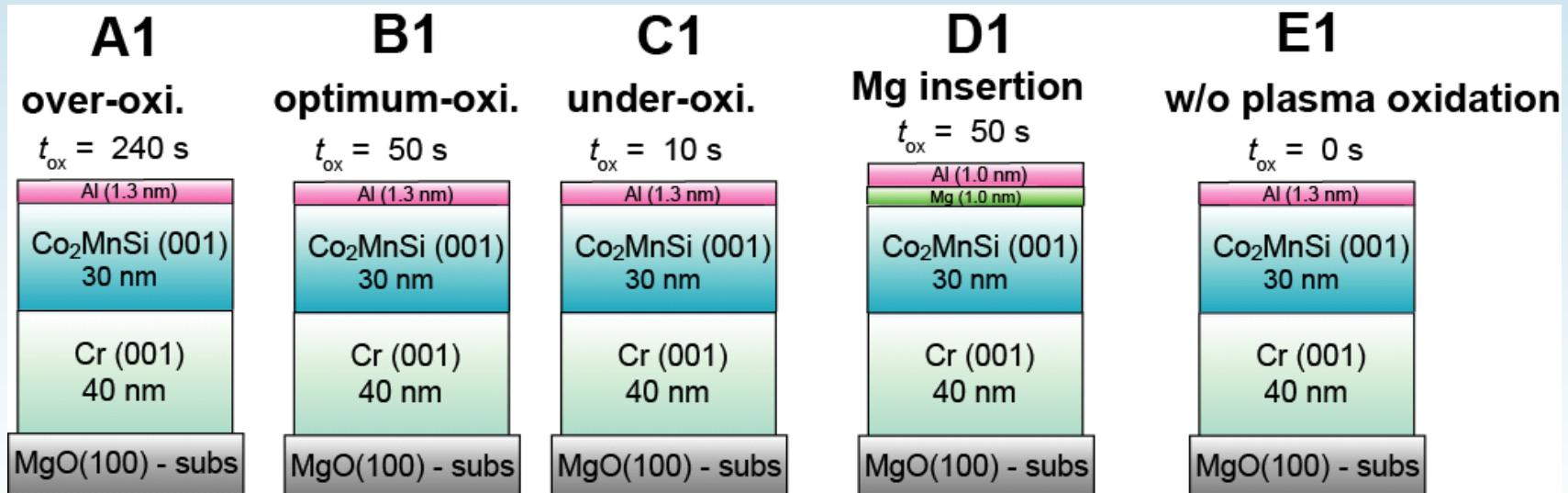
(Formation energy of oxide : Mg < Al, Co, Mn, Si)

Thickness of Mg layer : $t_{\text{Mg}} = 0 - 1.3 \text{ nm}$

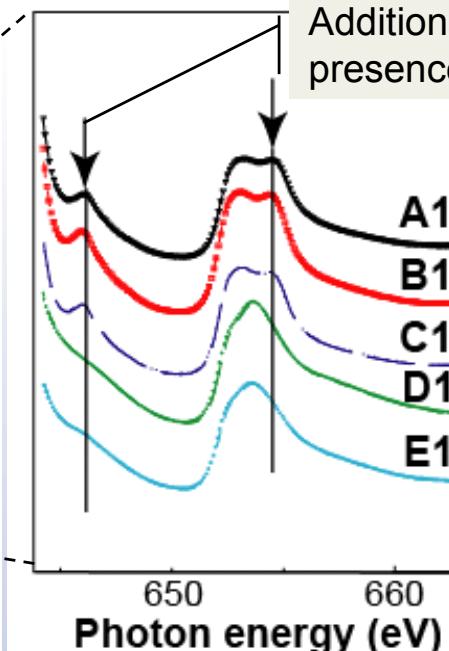
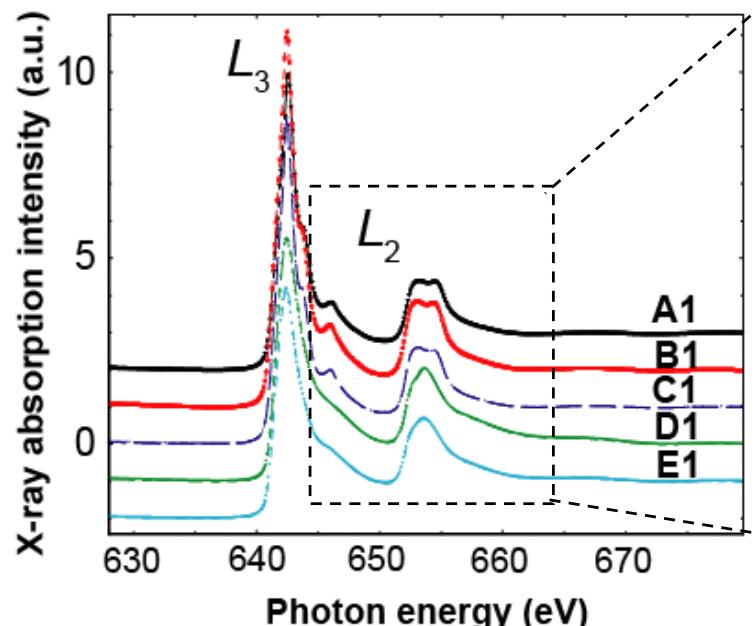
Experiment 1

CMS-based MTJs

Investigation of interfacial Mn impurities by XAS using TEY (ALS beamline 6.3.1)



XAS :Mn L-absorption edges

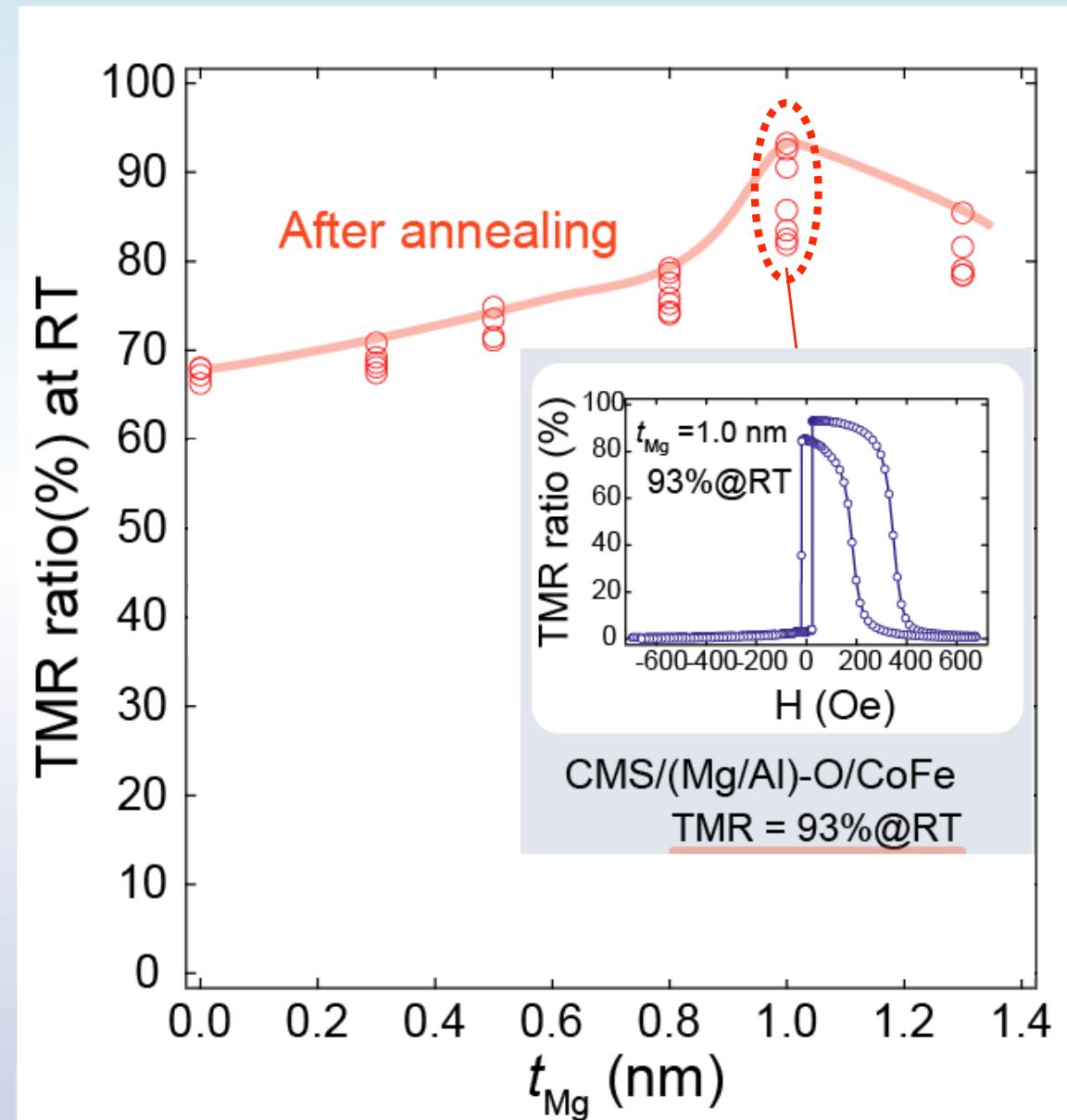
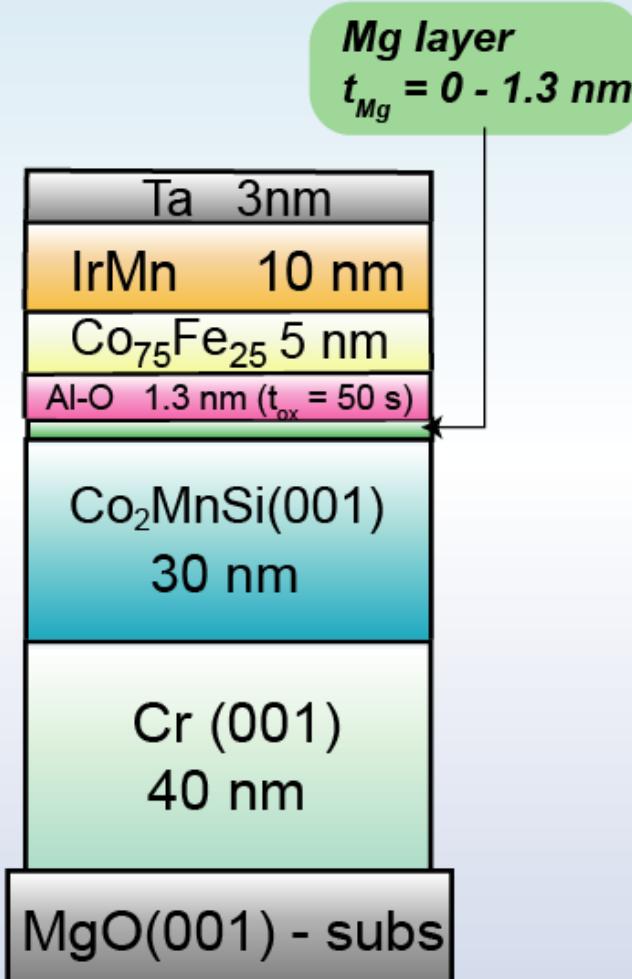


Additional multiplet structure indicates the presence of Mn-O impurities at interface.

A1, B1, C1:
large amount of Mn-O at interface

D1, E1:
few Mn-O at interface

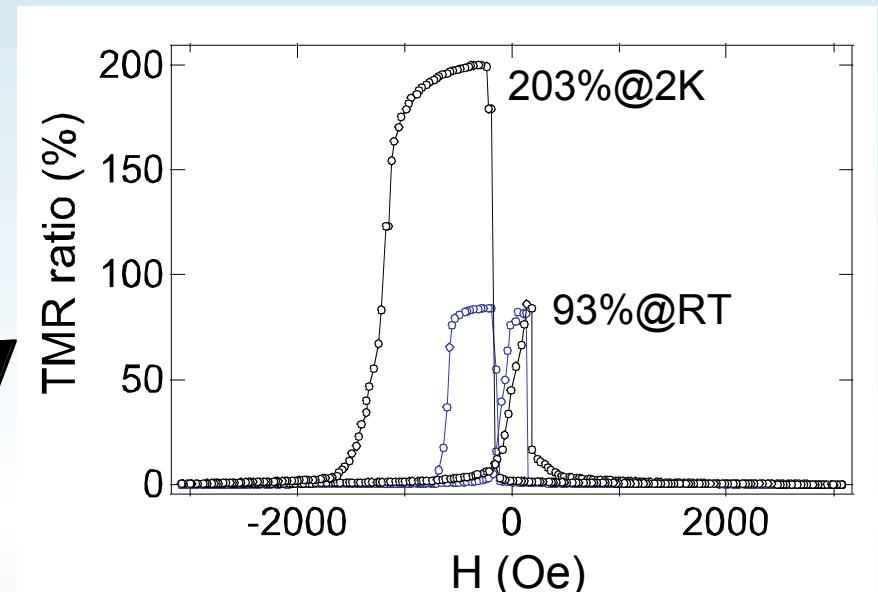
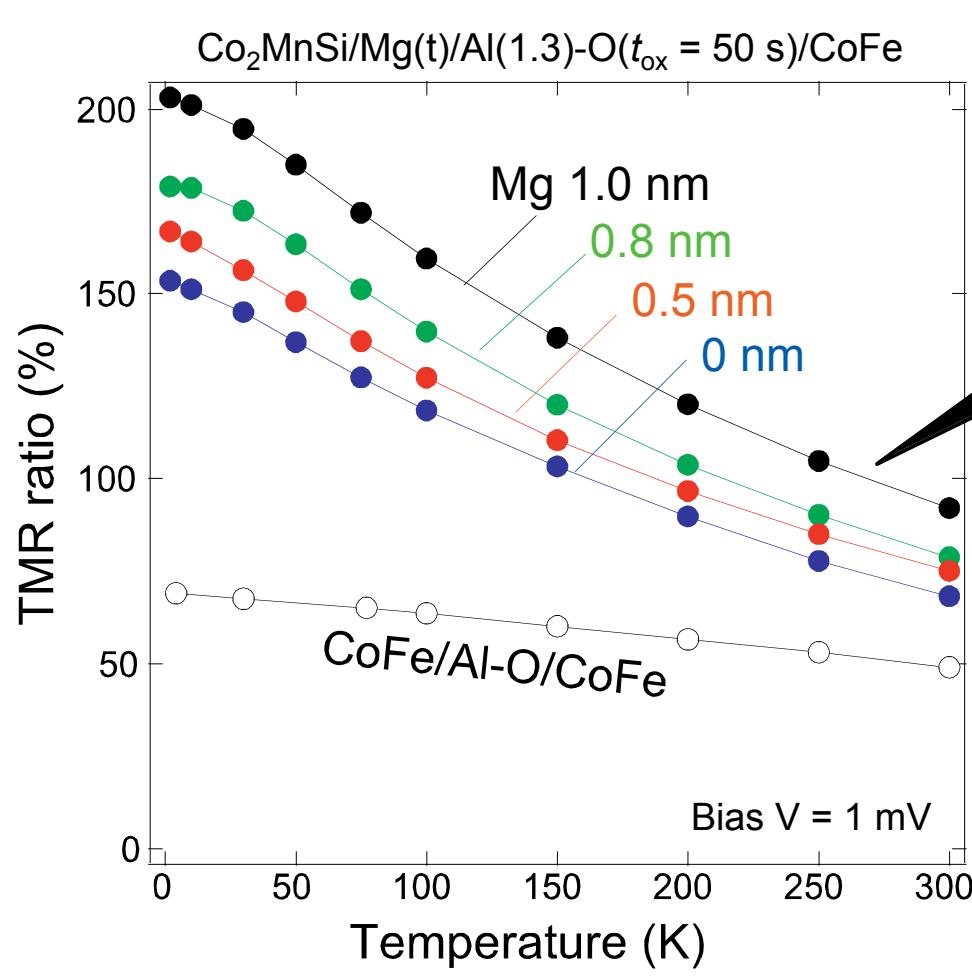
Mg thickness dependence of TMR ratio



Experiment 1

CMS-based MTJs

Temperature dependence of TMR ratio



CMS/Mg/Al-O/CoFe
 TMR = 203% (T = 2K)

$$0.50 < P_{\text{CoFe}} < 0.52$$

$$0.97 < P_{\text{Co}_2\text{MnSi}} < 1.00$$

Nearly ideal half-metallic spin-polarization

Sakuraba et al. J. Mag. Soc. Jpn. (2007)

XAS using TEY is an useful technique to investigate barrier interface quality in MTJs

Co₂MnSi based-MTJs

Co₂MnSi/Al-O/Co₂MnSi-MTJ

TMR = 67%(RT), 570%(2K)

Sakuraba *et al.* APL 88, 192508 (2006)

Co₂MnSi/MgO/CoFe-MTJ

TMR = 217%(RT), 753%(10K)

Tsunegi *et al.* APL 93, 112506 (2008)

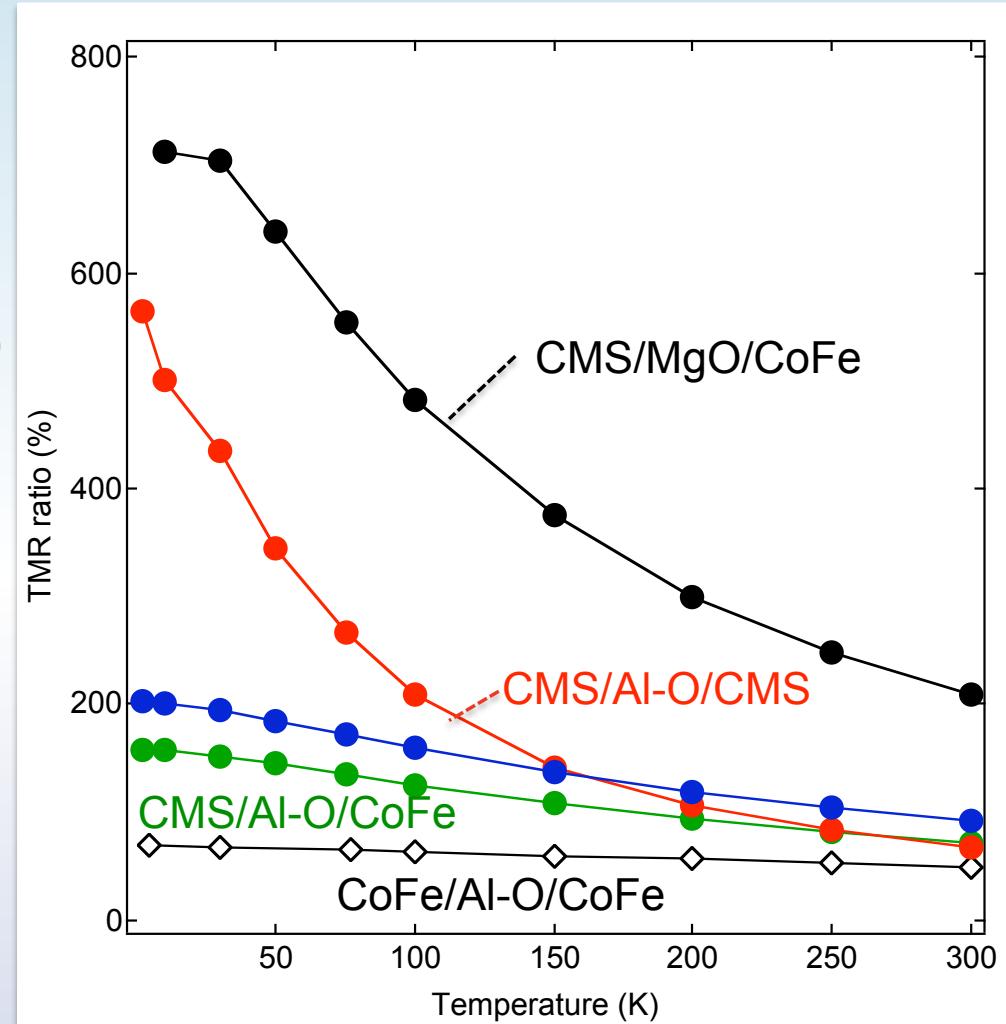
Co₂MnSi/MgO/Co₂MnSi-MTJ

TMR = 182%(RT), 705%(4.2K)

Ishikawai *et al.* JAP (2009)

cf. CoFeB/MgO/CoFeB-MTJ

TMR = 604%(RT), 1144%(4.2K)



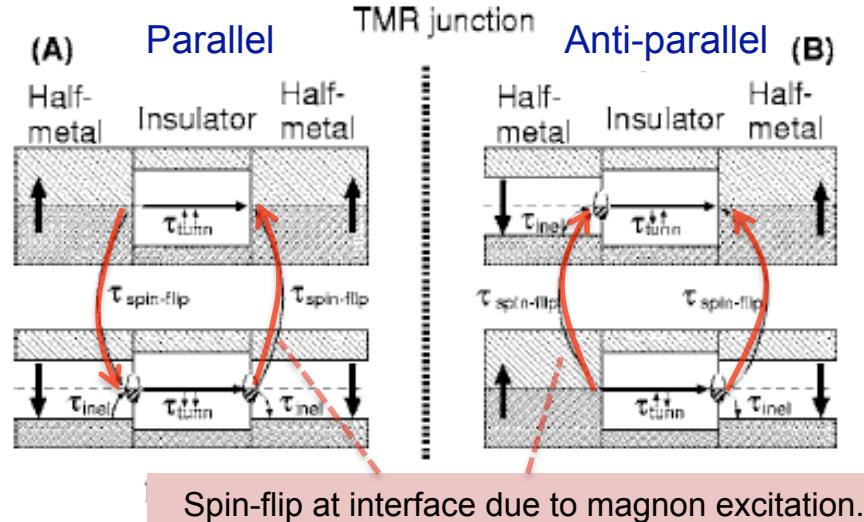
Disappearance of half-metallicity at RT is the largest problem in CMS-based MTJs.

Origin for disappearance of half-metallicity at RT

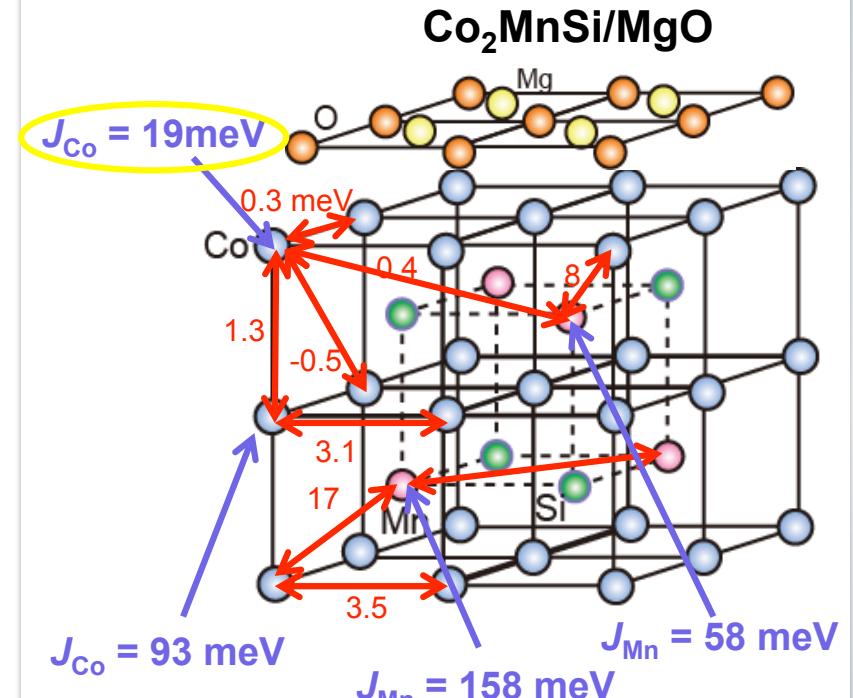
PHYSICAL REVIEW B 72, 174428 (2005)

Half-metallic ferromagnets for magnetic tunnel junctions by *ab initio* calculations

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 (Received 23 August 2005; published 29 November 2005)



Sakuma et al. J. Appl. Phys. 105, 07C910 (2009)



Weak exchange energy of Co at the interface.

Large magnon excitation by thermal energy is the most possible origin for disappearance of half-metallicity at RT in CMS-based MTJs.

Experiment 2 MTJs using L1₀/L2₁-ordered alloy hybrid electrodes

For developing Spin-RAM

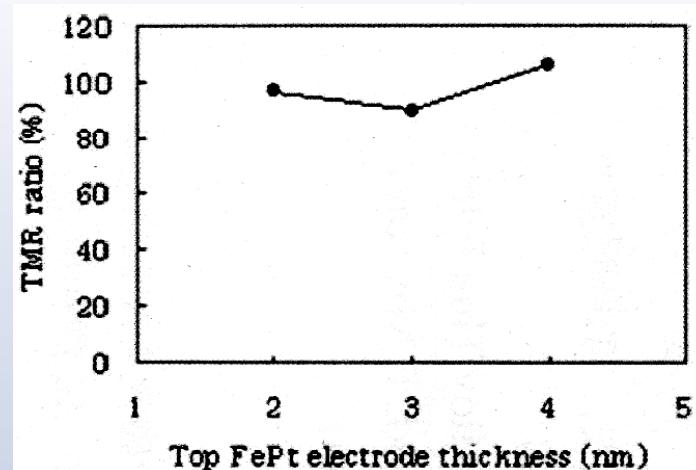
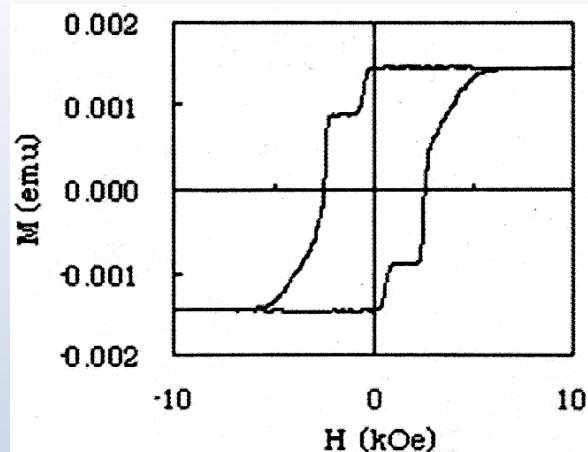
MTJs with perpendicular magnetized electrodes are recent trend.

- High thermal stability : $K_u V/k_B T > 60$
- Small critical current density of spin-transfer torque switching : $J_{C0} < 10^6 \text{ A/cm}^2$

FePt/Fe/MgO/FePt – MTJ

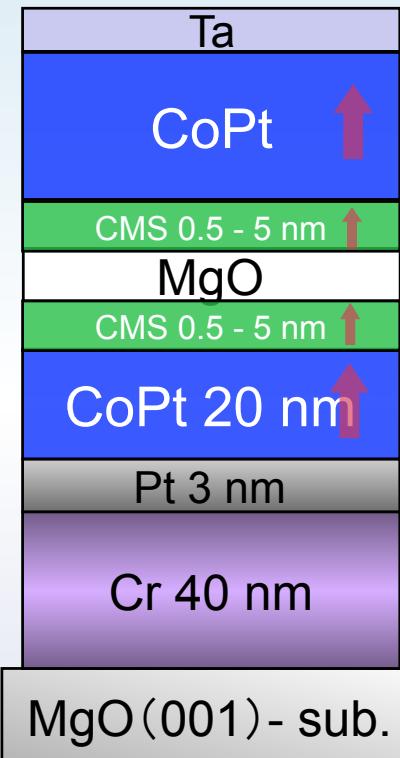
(MMM 2008, TOSHIBA)

→TMR ratio > 100% at R. T.



Experiment 2 MTJs using L1₀/L2₁-ordered alloy hybrid electrodes

Lattice misfit between CMS(001) and CoPt(001) ~ 4%
(001)-CoPt/CMS/MgO/CMS/CoPt fully-epitaxial MTJ can be fabricated.



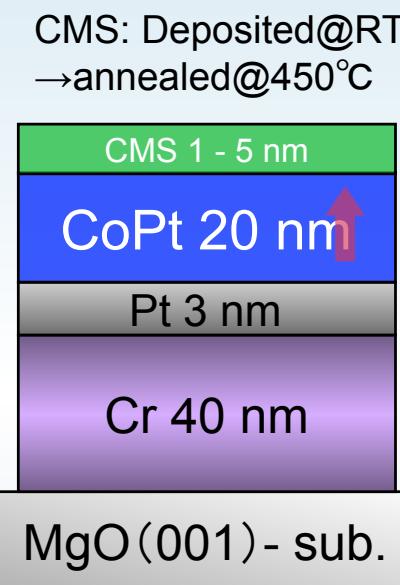
★ High thermal stability due to large magnetic anisotropy

Suppression of magnon excitation at CMS/barrier interface.

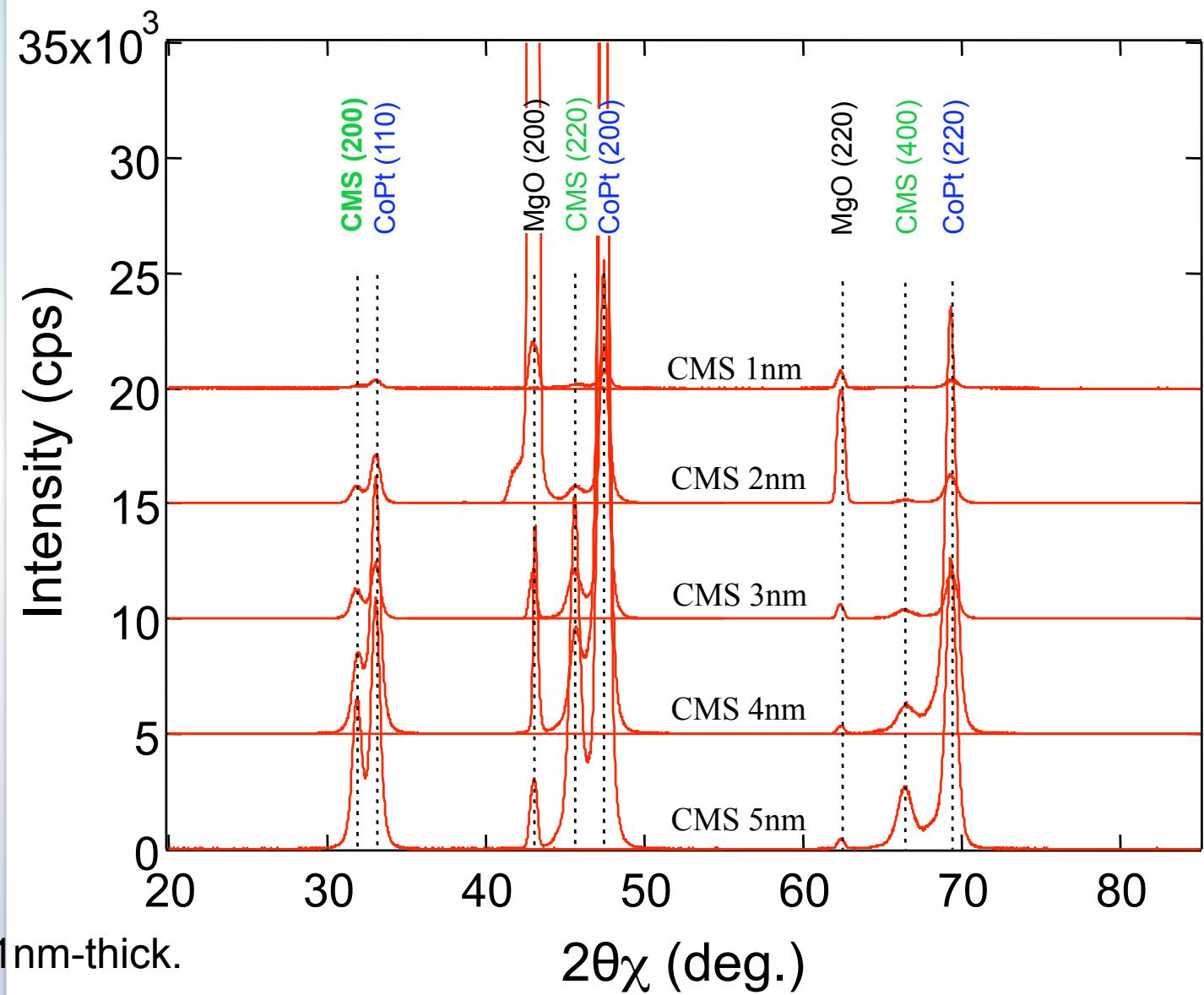
★ Large spin-polarization (TMR ratio) at RT

Experiment 2 MTJs using L1₀/L2₁-ordered alloy hybrid electrodes

Structural analysis : XRD in-plane geometry (X-ray incident angle $2\theta < 0.4\text{deg.}$)

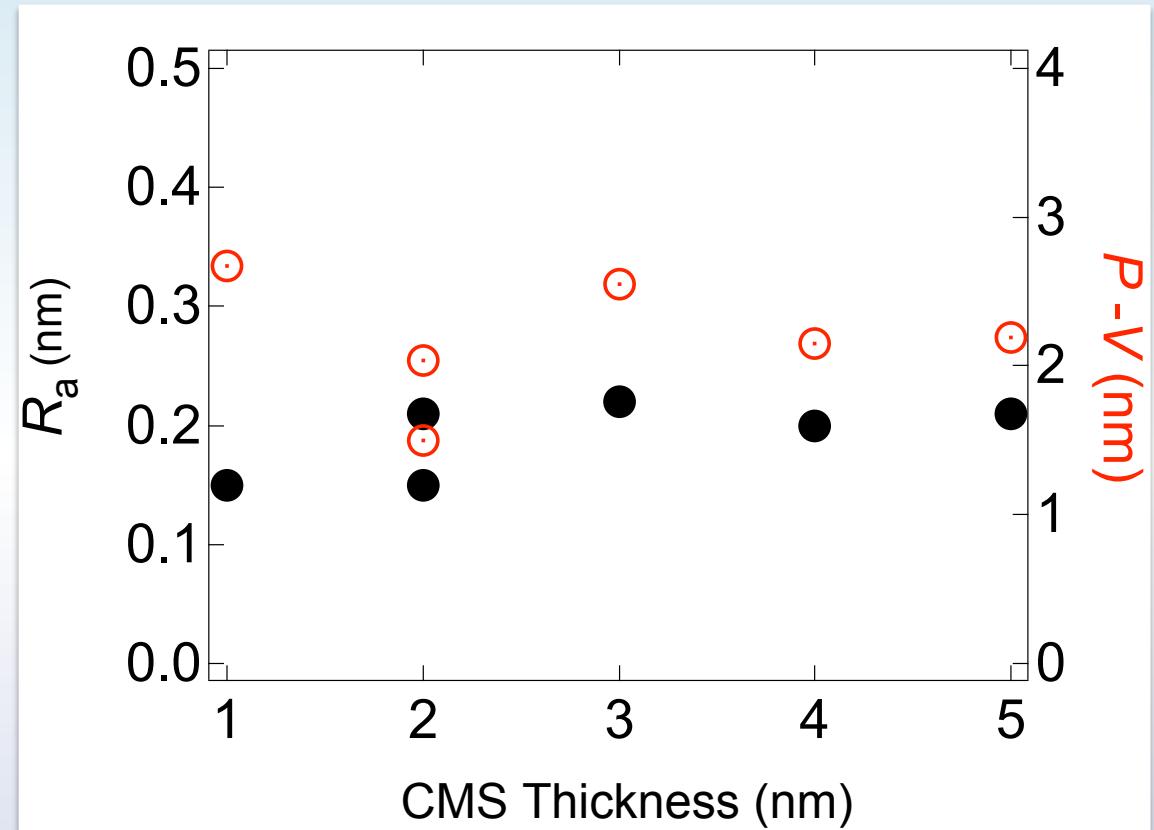
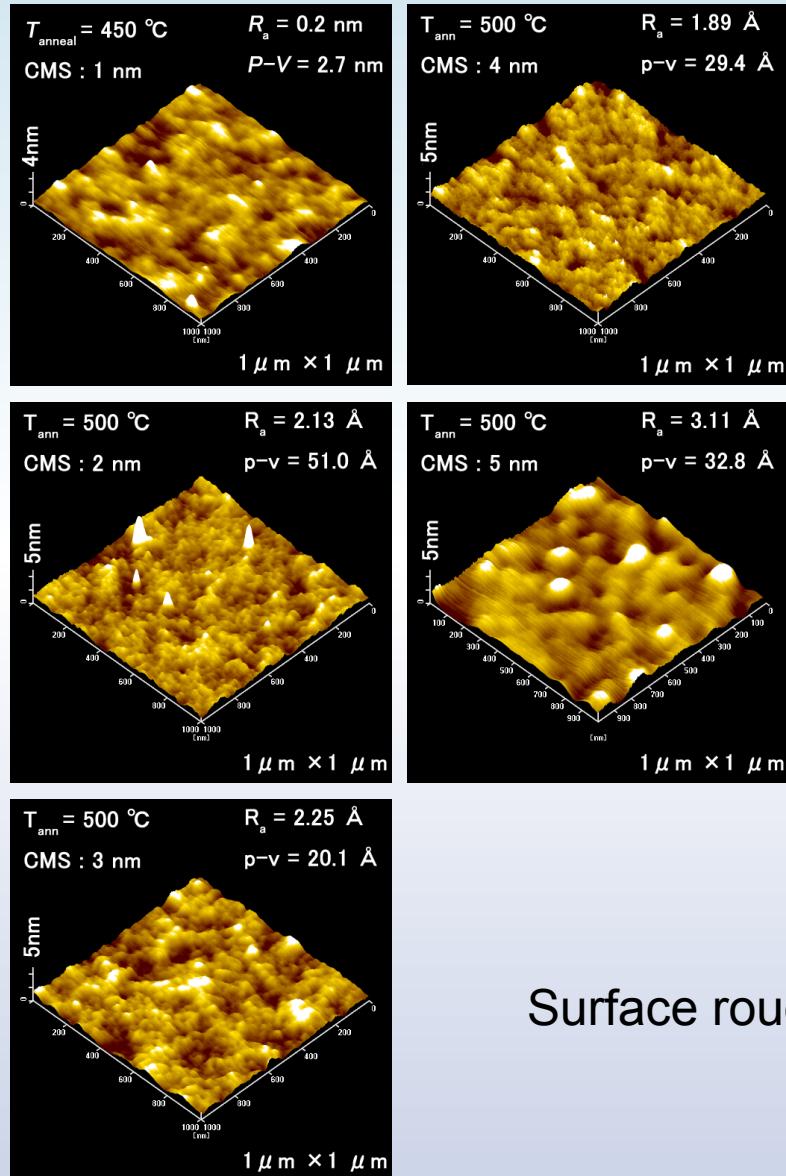


- fully epitaxial growth
 - B2-ordering even in 1nm-thick.



Experiment 2 MTJs using L₁₀/L₂₁-ordered alloy hybrid electrodes

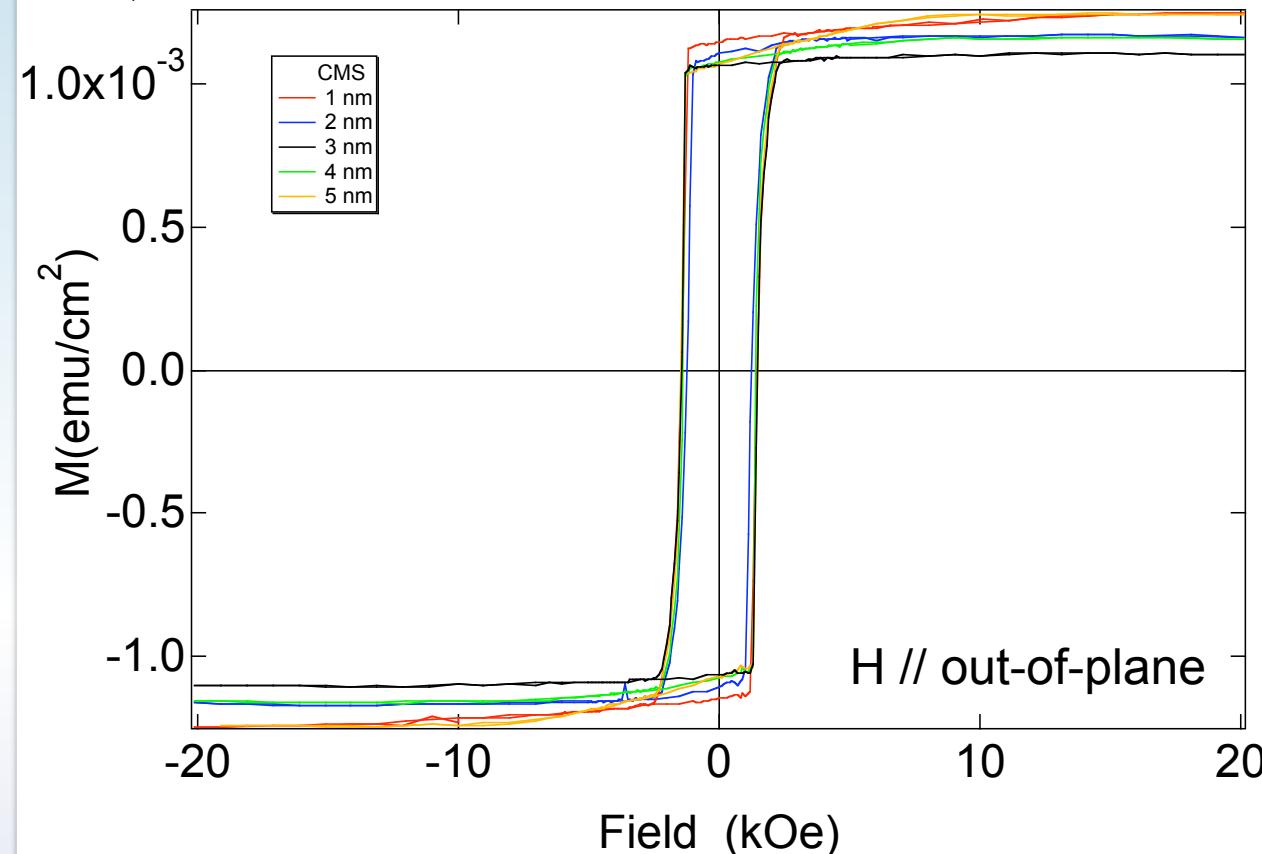
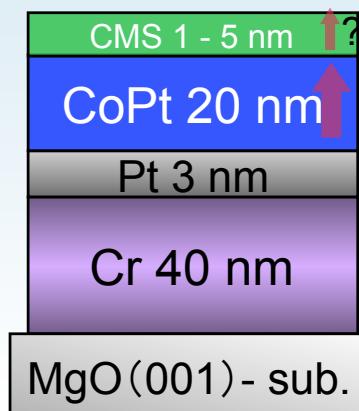
Surface flatness : AFM



Surface roughness is enough small to deposit MgO barrier.

Experiment 2 MTJs using L1₀/L2₁-ordered alloy hybrid electrodes

M-H curves : SQUID, VSM



Magnetic behavior of CMS layer can not be identified because of...

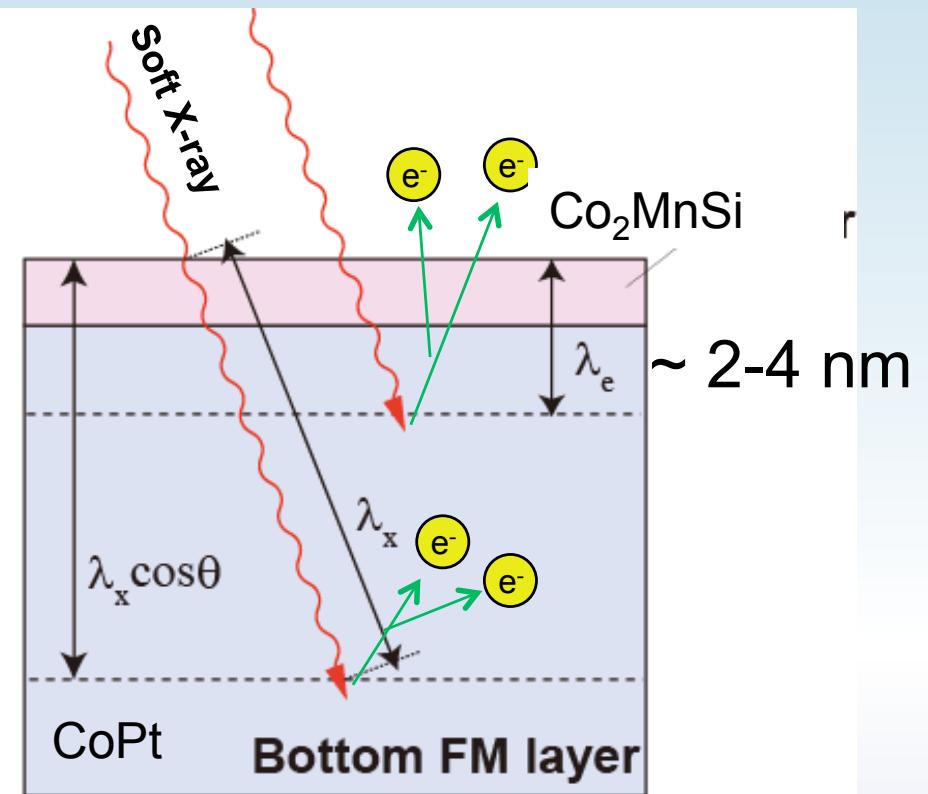
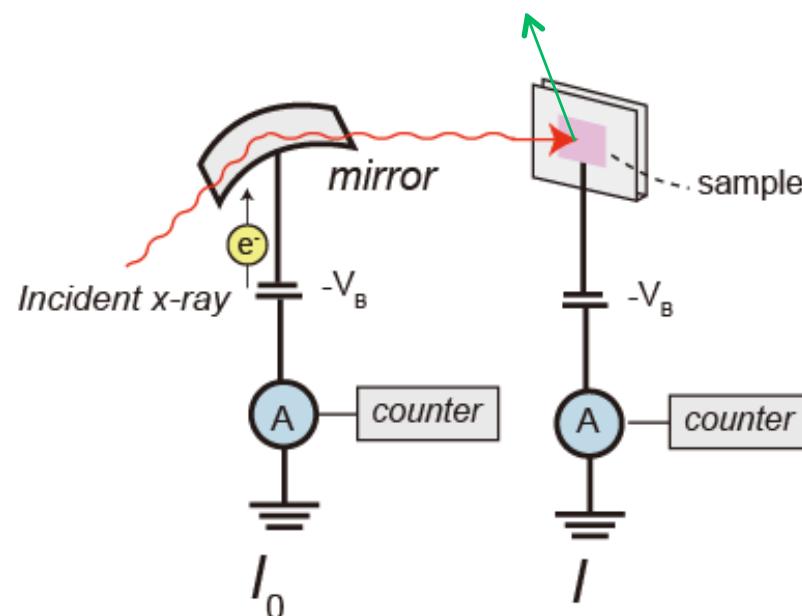
- (1) too small M_{CMS} compared with M_{CoPt}
- (2) the error in subtraction procedure of MgO-subs contribution

Other experimental techniques to observe surface moment is needed.

XMCD

Experiment 2 MTJs using L1₀/L2₁-ordered alloy hybrid electrodes

Total electron yield (TEY) method



XMCD : SPring-8 BL25SU

λ_x : penetration length of X-ray

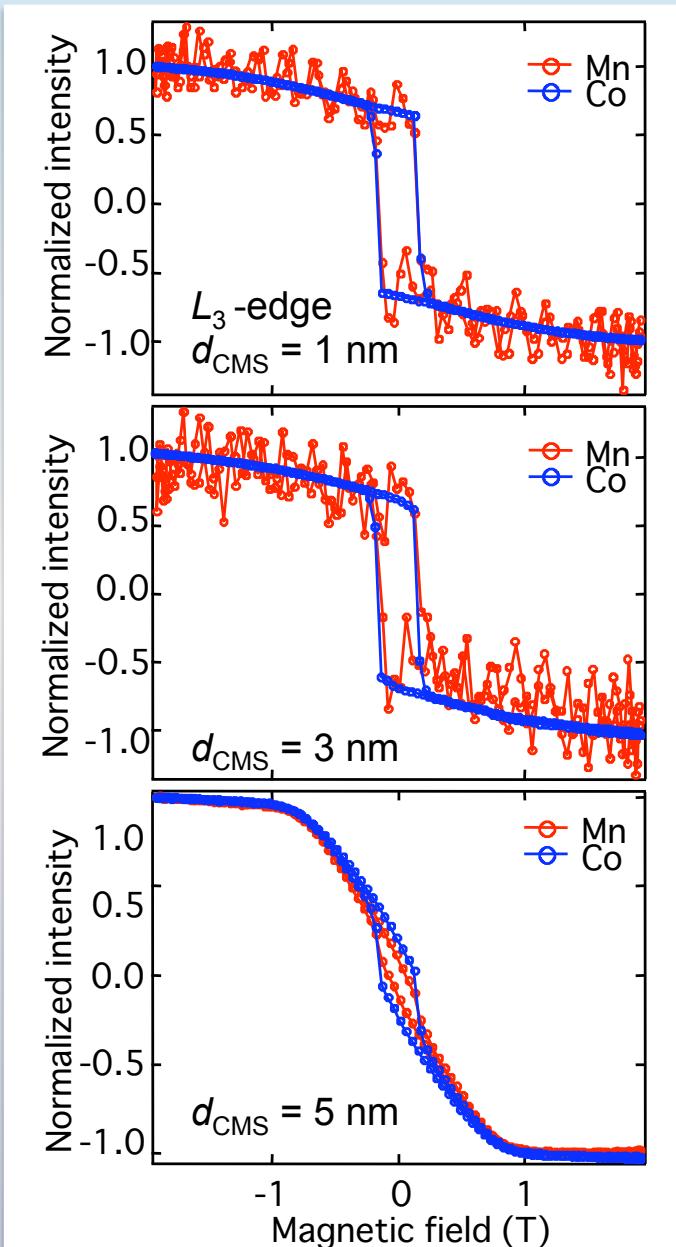
$\lambda_x \cos\theta$: penetration depth of X-ray

λ_e : escape depth of photo electron

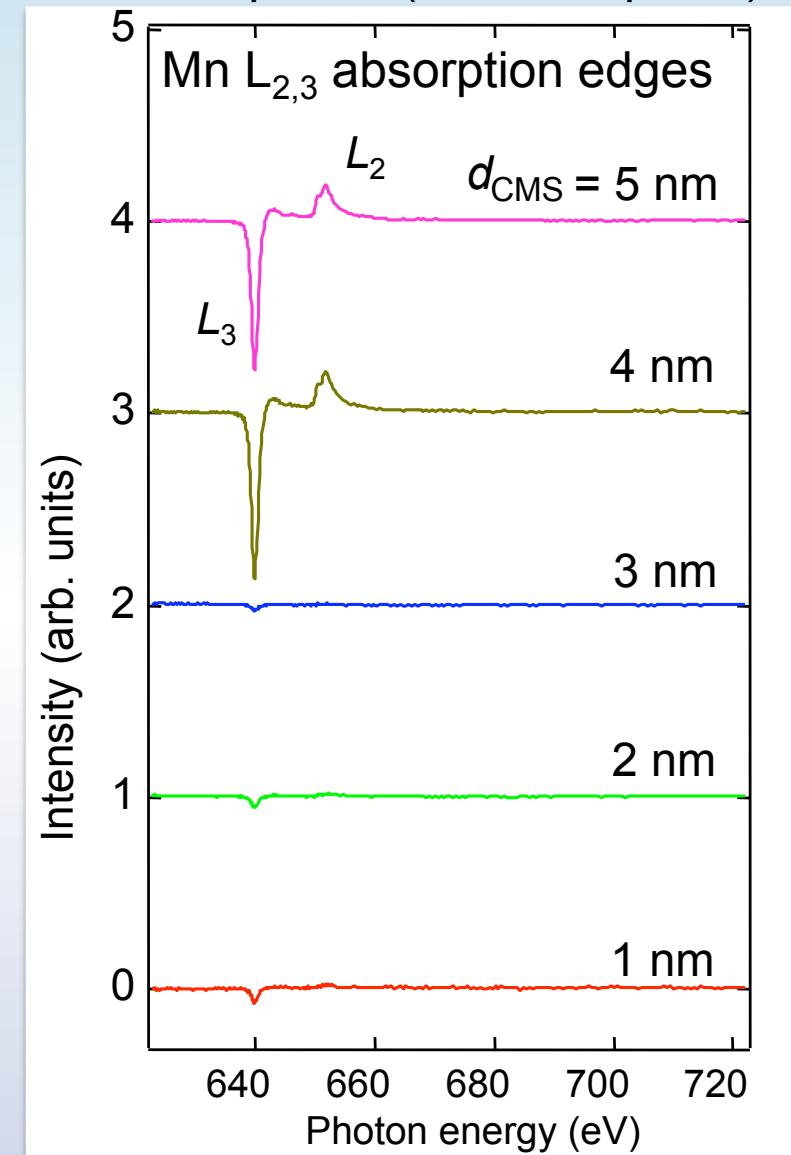
Elements specific (Co and Mn) M-H curves can be measured.

Experiment 2 MTJs using L₁₀/L₂₁-ordered alloy hybrid electrodes

Element specific M-H (H//out-of-plane)



XMCD spectra (H//out-of-plane)



• $d_{\text{CMS}} < 3 \text{ nm}$: CMS has perpendicular magnetic anisotropy, but magnetic moment is very small.

What is the next generation reading head?

Requirements : Large MR ratio for high S/N ratio, Small RA for high speed reading

● MgO-MTJs

Large MR ratio, but difficult to achieve small RA.

CoFeB/MgO/CoFeB : RA = $0.4 \Omega \cdot \mu\text{m}^2$, MR = 50%
Nagamine et al. APL(2006)
 RA = $2.1 \Omega \cdot \mu\text{m}^2$, MR = 206%
Isogami et al. MSJ conf.(2008)

● CPP-GMR

Small RA, but difficult to achieve large MR ratio.

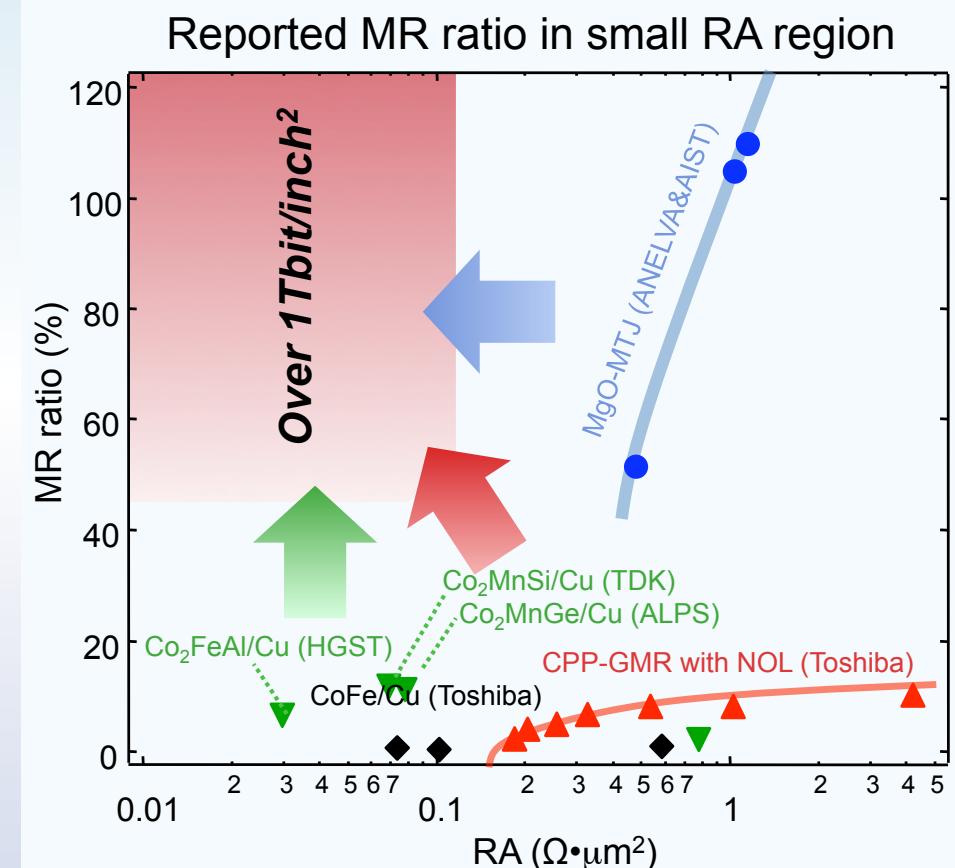
CoFe/Cu/CoFe : RA = $0.12 \Omega \cdot \mu\text{m}^2$, MR = 1.3%
Yuasa et al. JAP(2002)

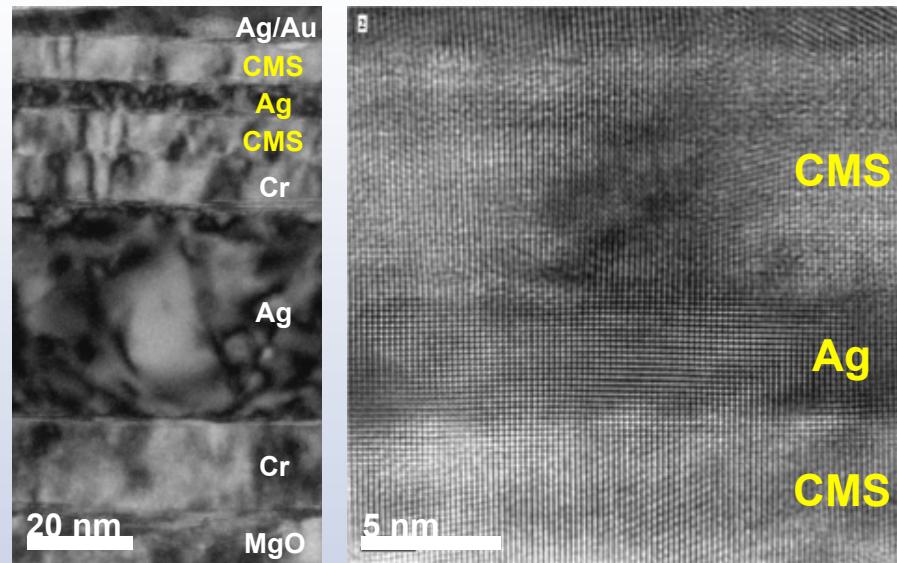
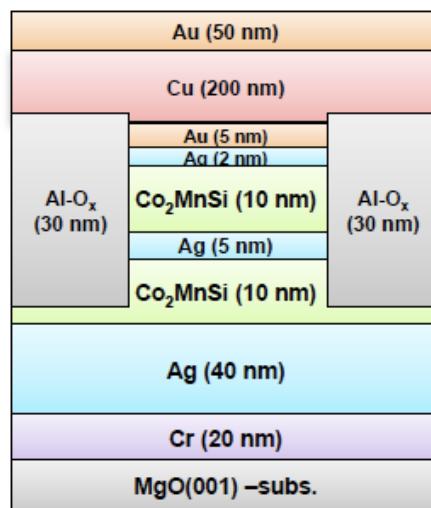
(i) Using Nano-oxide layer(NOL)

CoFe/NOL/CoFe : RA = $0.58 \Omega \cdot \mu\text{m}^2$, MR = 8.2%
Fukuzawa et al. JPD(2007)

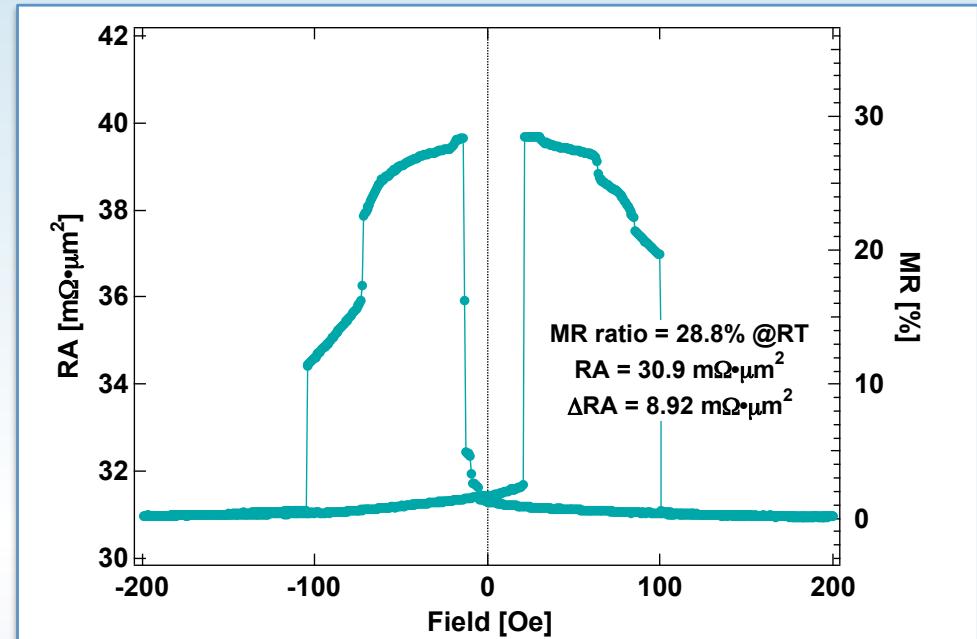
(ii) Using half-metallic full-Heusler alloy

Co₂MnGe/Cu/Co₂MnGe : RA = $0.079 \Omega \cdot \mu\text{m}^2$, MR = 11.5%
Saito et al. Intermag(2004)



CMS/Ag/CMS fully epitaxial CPP-GMR device


HR-TEM image



◆ The highest MR ratio (28.8%@RT) is the best record in all of the reports to date.

cf. CoFe/Cu/CoFe : MR ~ 2.3%@RT

Summary

- XAS based on TEY is an useful technique to observe interfacial chemical state between barrier and FM electrodes in MTJs.
- Element specific magnetization measurement based on XMCD is an helpful technique to fabricate new types of half-metals such as, perpendicular magnetized half-metals and ferri-magnetic half-metals.